

**KLT-D3MA-IMX258 V1.4****13MP Sony IMX258 MIPI Interface Auto Focus Camera Module**

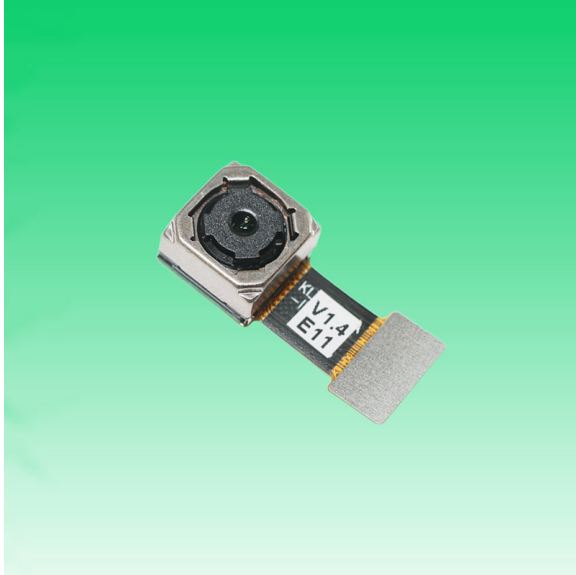
Front View



Back View

**Specifications**

<b>Camera Module No.</b>	<b>KLT-D3MA-IMX258 V1.4</b>
<b>Resolution</b>	13MP
<b>Image Sensor</b>	IMX258
<b>Sensor Type</b>	1/3.06"
<b>Pixel Size</b>	1.12 um x 1.12 um
<b>EFL</b>	3.85 mm
<b>F.NO</b>	2.20
<b>Pixel</b>	4224 x 3136
<b>View Angle</b>	74.4°(DFOV) 62.7°(HFOV) 48.7°(VFOV)
<b>Lens Dimensions</b>	8.50 x 8.50 x 5.60 mm
<b>Module Size</b>	20.85 x 8.50 mm
<b>Module Type</b>	Auto Focus
<b>Interface</b>	MIPI
<b>Auto Focus VCM Driver IC</b>	DW9763
<b>Lens Type</b>	650nm IR Cut
<b>Operating Temperature</b>	-20°C to +70°C
<b>Mating Connector</b>	BBR43-30KB533

**KLT-D3MA-IMX258 V1.4****13MP Sony IMX258 MIPI Interface Auto Focus Camera Module**

Top View



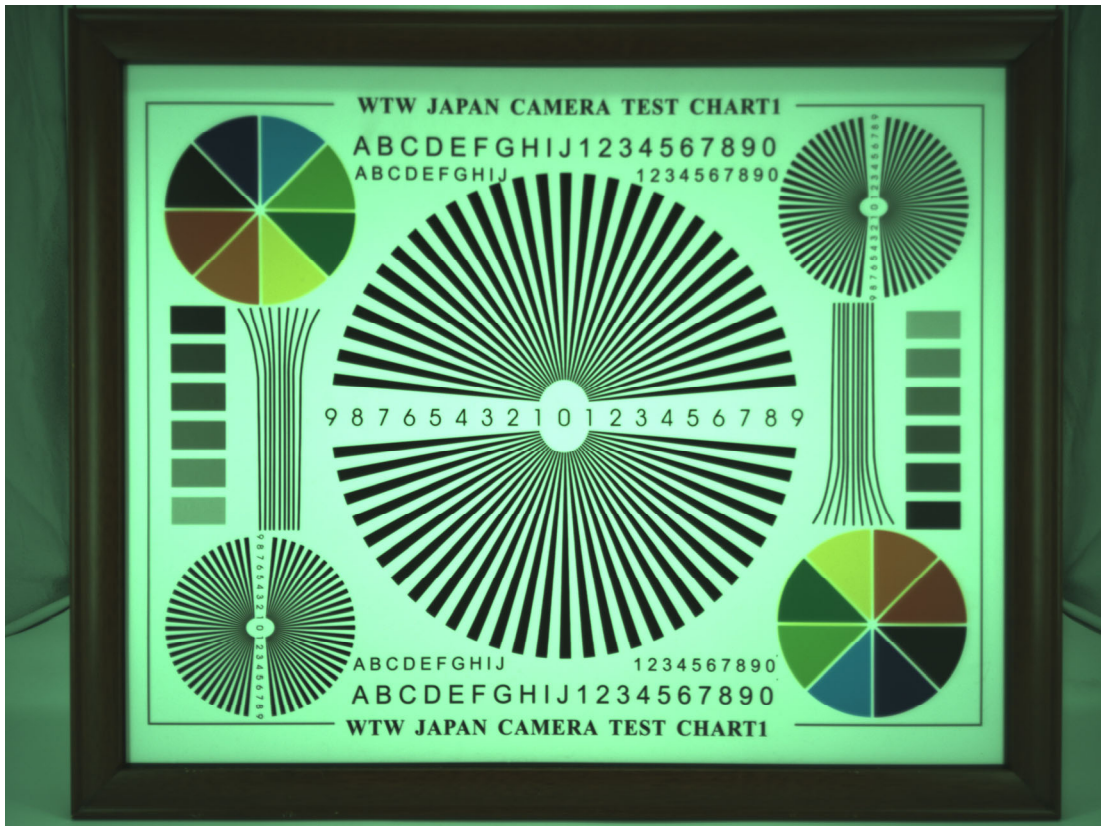
Side View



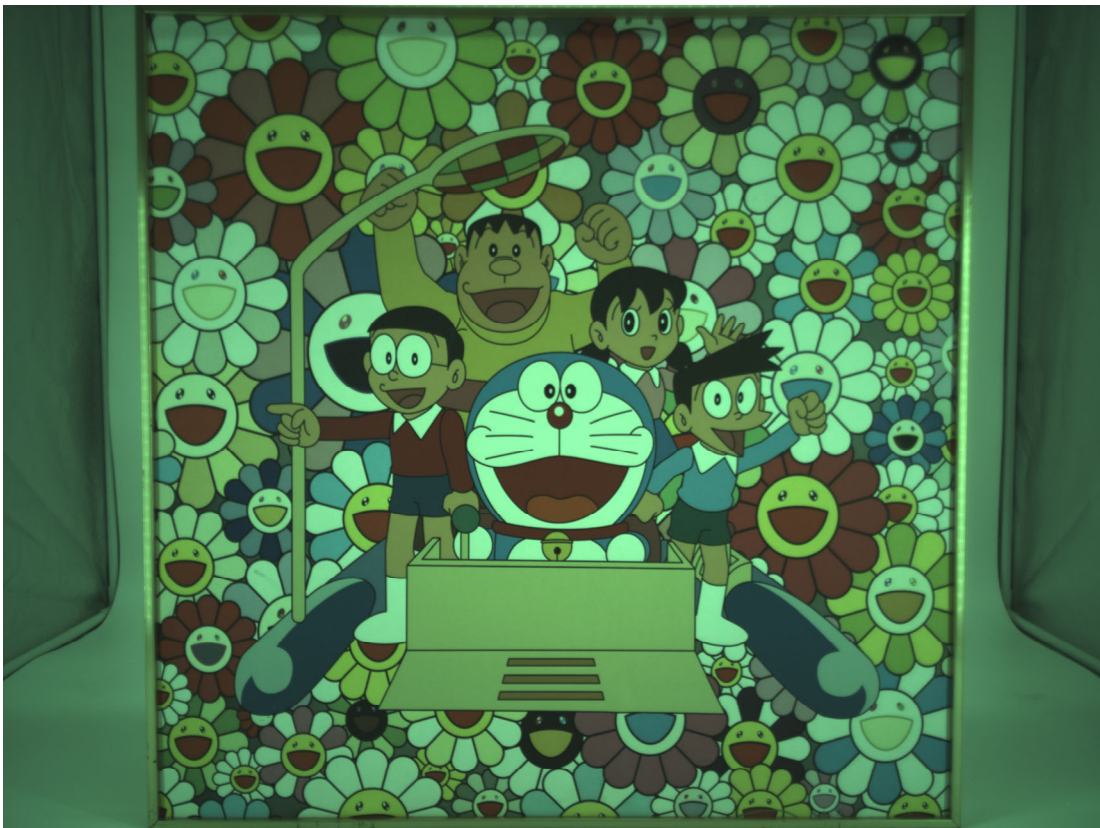
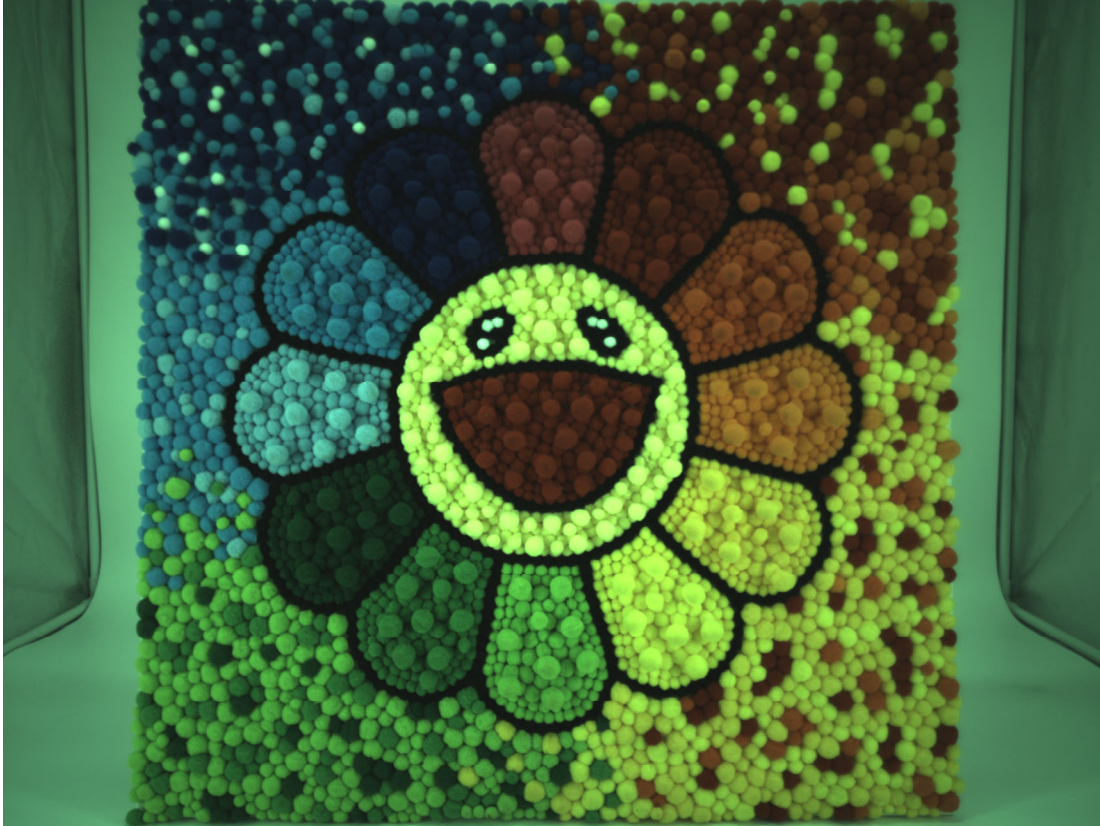
Bottom View

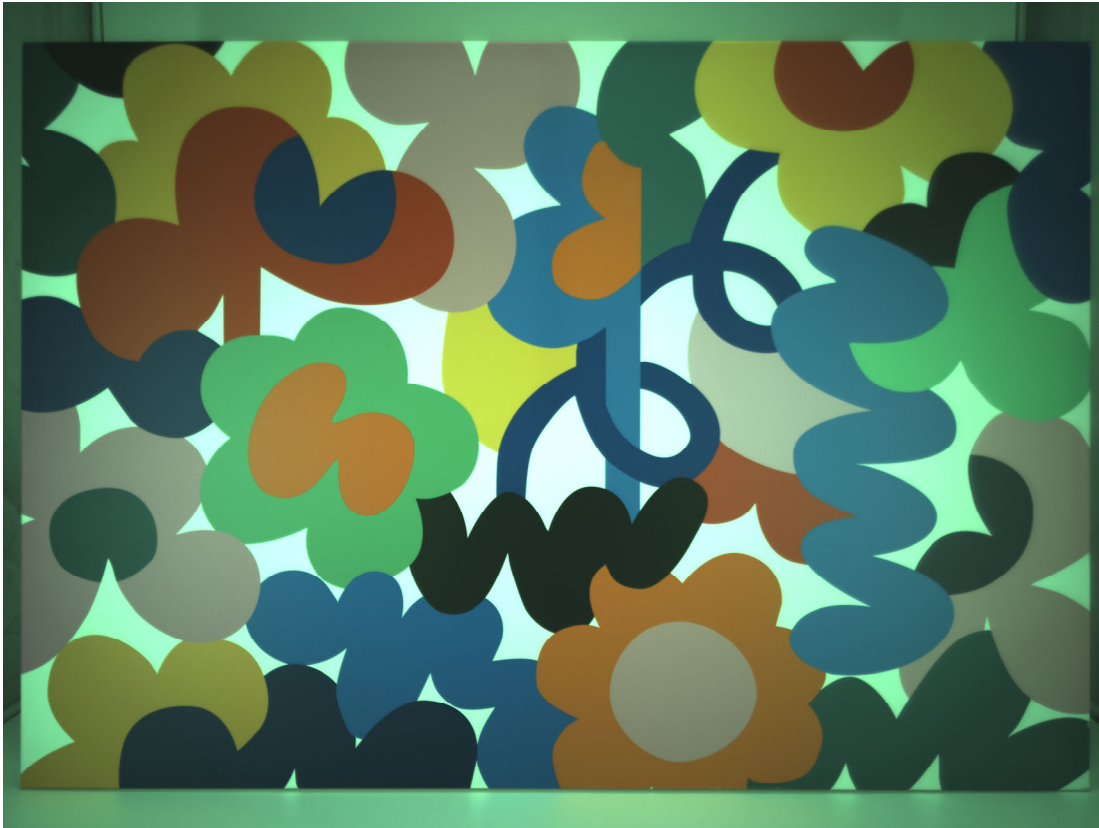


Mating Connector









GROUP

1 H  
Hydrogen

3 Li  
Lithium

11 Na  
Sodium

19 K  
Potassium

37 Rb  
Rubidium

55 Cs  
Cesium

87 Fr  
Francium

4 Be  
Beryllium

12 Mg  
Magnesium

20 Ca  
Calcium

38 Sr  
Strontium

56 Ba  
Barium

88 Ra  
Radium

5 B  
Boron

13 Al  
Aluminum

21 Ga  
Gallium

39 In  
Indium

57 Tl  
Thallium

89 Bi  
Bismuth

101 Nh  
Nihonium

6 C  
Carbon

14 Si  
Silicon

22 Ge  
Germanium

40 Sn  
Tin

58 Pb  
Lead

84 Po  
Polonium

102 Fl  
Flerovium

7 N  
Nitrogen

15 P  
Phosphorus

23 As  
Arsenic

41 Sb  
Antimony

59 Bi  
Bismuth

85 At  
Astatine

103 Ts  
Tennessine

8 O  
Oxygen

16 S  
Sulfur

24 Se  
Selenium

42 Te  
Tellurium

60 Po  
Polonium

86 Lv  
Livermorium

104 Og  
Oganesson

9 F  
Fluorine

17 Cl  
Chlorine

25 Br  
Bromine

43 I  
Iodine

61 At  
Astatine

87 Ts  
Tennessine

105 Uu  
Ununpentium

10 Ne  
Neon

18 Ar  
Argon

26 Kr  
Krypton

44 Xe  
Xenon

62 Rn  
Radon

88 Og  
Oganesson

12 He  
Helium

20 Ne  
Neon

28 Ar  
Argon

36 Kr  
Krypton

44 Xe  
Xenon

62 Rn  
Radon

88 Og  
Oganesson

# Periodic table of Elements

- Hydrogen (Gas)
- Alkali Metals
- Alkaline Earth Metals
- Transition Metals
- Other Metals
- Metalloids
- Non-metals
- Halogens
- Noble Gases
- Lanthanides
- Actinides

Average Atomic Mass

Atomic Number

Name

Symbol

5 B  
Boron

6 C  
Carbon

7 N  
Nitrogen

8 O  
Oxygen

9 F  
Fluorine

10 Ne  
Neon

13 Al  
Aluminum

14 Si  
Silicon

15 P  
Phosphorus

16 S  
Sulfur

17 Cl  
Chlorine

18 Ar  
Argon

29 Cu  
Copper

30 Zn  
Zinc

31 Ga  
Gallium

32 Ge  
Germanium

33 As  
Arsenic

34 Se  
Selenium

45 Rh  
Rhodium

46 Pd  
Palladium

47 Ag  
Silver

48 Cd  
Cadmium

49 In  
Indium

50 Sn  
Tin

59 Ni  
Nickel

60 Cu  
Copper

61 Zn  
Zinc

62 Ga  
Gallium

63 Ge  
Germanium

64 As  
Arsenic

79 Au  
Gold

80 Hg  
Mercury

81 Tl  
Thallium

82 Pb  
Lead

83 Bi  
Bismuth

84 Po  
Polonium

97 Bk  
Berkelium

98 Cf  
Californium

99 Es  
Einsteinium

100 Fm  
Fermium

101 Md  
Mendelevium

102 No  
Nobelium

57 La  
Lanthanum

58 Ce  
Cerium

59 Pr  
Praseodymium

60 Nd  
Neodymium

61 Pm  
Promethium

62 Sm  
Samarium

63 Eu  
Europium

64 Gd  
Gadolinium

65 Tb  
Terbium

66 Dy  
Dysprosium

67 Ho  
Holmium

68 Er  
Erbium

69 Tm  
Thulium

70 Yb  
Ytterbium

71 Lu  
Lutetium

89 Ac  
Actinium

90 Th  
Thorium

91 Pa  
Protactinium

92 U  
Uranium

93 Np  
Neptunium

94 Pu  
Plutonium

95 Am  
Americium

96 Cm  
Curium

97 Bk  
Berkelium

98 Cf  
Californium

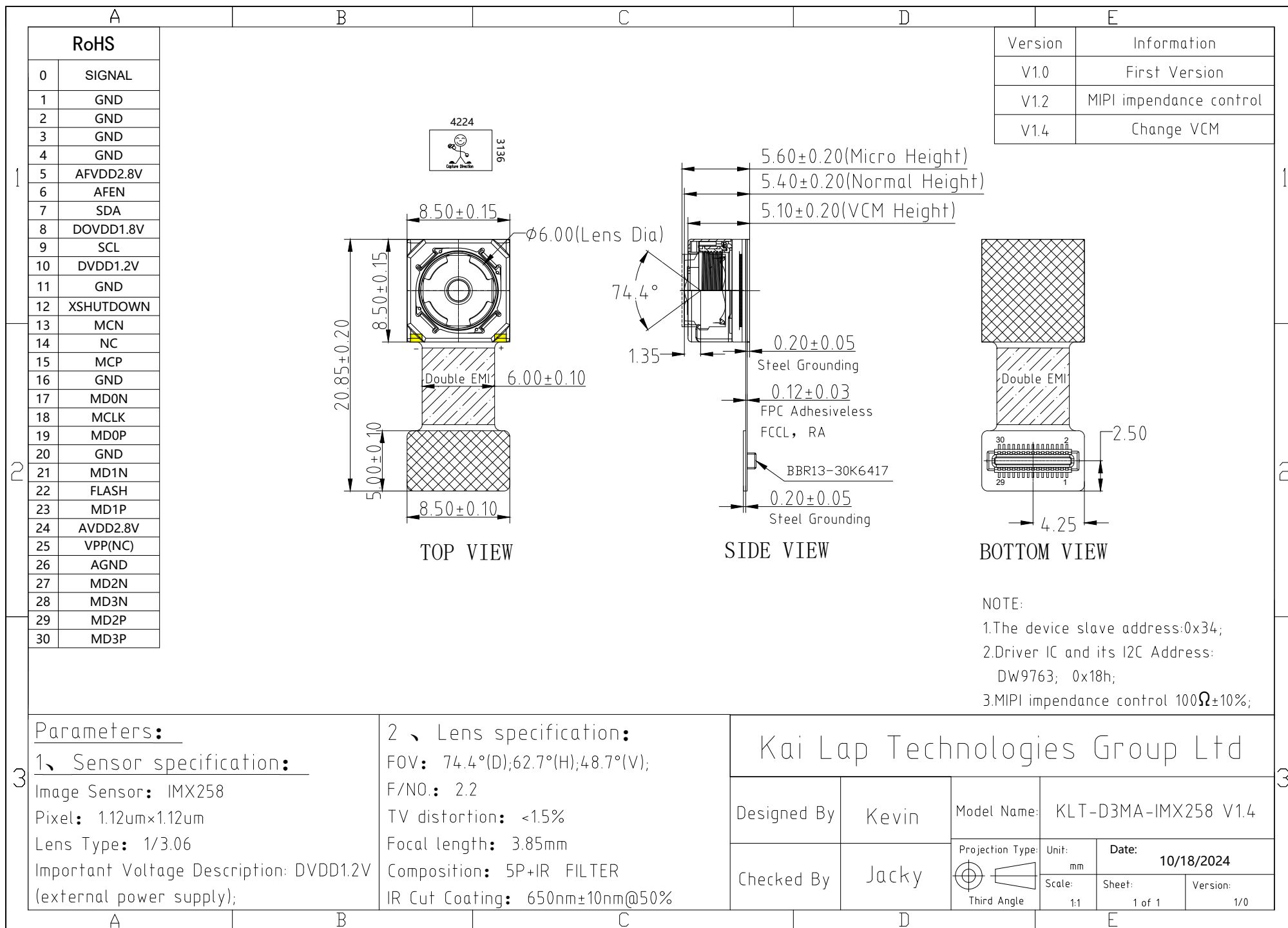
99 Es  
Einsteinium

100 Fm  
Fermium

101 Md  
Mendelevium

102 No  
Nobelium

103 Lr  
Lawrencium





## [Product Brief]

Ver.1.0

# IMX258

Diagonal 5.867 mm (Type 1/3.06) 13Mega-Pixel CMOS Image Sensor with Square Pixel for Color Cameras

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### Description

IMX258 is a diagonal 5.867mm (Type 1/3.06) 13 Mega-pixel CMOS active pixel type stacked image sensor with a square pixel array. It adopts Exmor R<sup>TM</sup> technology to achieve high speed image capturing by column parallel A/D converter circuits and high sensitivity and low noise image (comparing with conventional CMOS image sensor) through the backside illuminated imaging pixel structure. R, G, and B pigment primary color mosaic filter is employed. By introducing spatially multiplexed exposure technology, high dynamic range still pictures and movies are achievable. It

equips an electronic shutter with variable integration time. It operates with three power supply voltages: analog 2.7 V, digital 1.2 V and 1.8 V for input/output interface and achieves low power consumption.

In addition, this product is designed for use in cellular phone and tablet pc. When using this for another application, Sony does not guarantee the quality and reliability of product. Therefore, don't use this for applications other than cellular phone and tablet pc. Consult your Sony sales representative if you have any questions.

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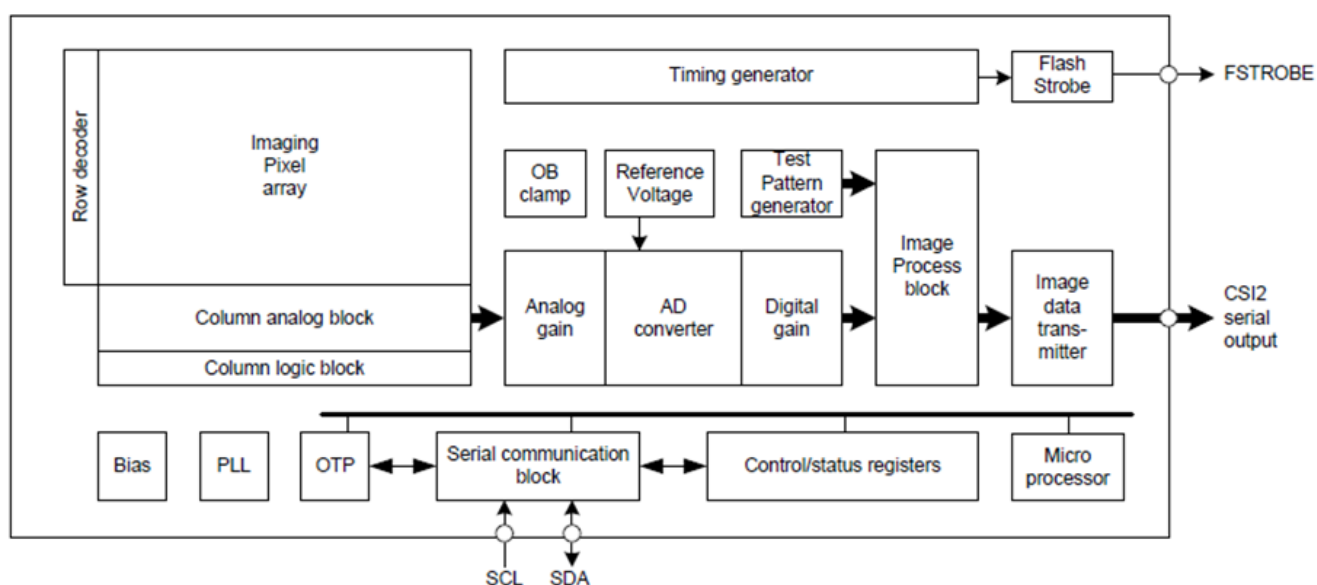
### Functions and Features

- ◆ Back-illuminated and stacked CMOS image sensor Exmor RSTM
- ◆ Phase Detection pixel data output for Phase Detection Auto Focus
- ◆ High Dynamic Range (HDR) mode with raw data output.
- ◆ High signal to noise ratio (SNR).
- ◆ Full resolution @30fps (Normal / HDR). 4K2K @30fps (Normal / HDR) 1080p @60fps (Normal )
- ◆ Output video format of RAW10/8.
- ◆ Pixel binning readout and V sub-sampling function.
- ◆ Independent flipping and mirroring.
- ◆ CSI-2 serial data output (MIPI 2lane/4lane, Max. 1.3Gbps/lane, D-PHY spec. ver. 1.1 compliant)
- ◆ 2-wire serial communication.
- ◆ Two PLLs for independent clock generation for pixel control and data output interface.
- ◆ Dynamic Defect Pixel Correction.
- ◆ Fast mode transition. (on the fly)
- ◆ Dual sensor synchronization operation.
- ◆ 4K bit of OTP ROM for users.
- ◆ Built-in temperature sensor.

## Device Structure

- ◆ CMOS image sensor
- ◆ Image size : Diagonal 5.867 mm (Type 1/3.06)
- ◆ Total number of pixels : 4224 (H) × 3192 (V) approx. 13.48 M pixels
- ◆ Number of effective pixels : 4224 (H) × 3144 (V) approx. 13.28 M pixels
- ◆ Number of active pixels : 4208 (H) × 3120 (V) approx. 13.13 M pixels
- ◆ Chip size : 5.990 mm (H) × 3.908 mm (V)
- ◆ Unit cell size : 1.12  $\mu\text{m}$  (H) × 1.12  $\mu\text{m}$  (V)
- ◆ Substrate material : Silicon

System block diagram



## Exmor RS

\* Exmor RS is a trademark of Sony Corporation. The Exmor RS is a Sony's CMOS image sensor with high-resolution, high-performance and compact size by replacing a supporting substrate in Exmor R™ which changed fundamental structure of Exmor™ pixel adopted column parallel A/D converter to back-illuminated type, with layered chips formed signal processing circuits.



## 1. General Description

The DW9763 is a single 10-bit DAC with 100mA output current sinking capability and embedded 8KByte eFlash memory. Designed for linear control of voice coil motors, the DW9763 is capable of operating voltage up to 3.3V.

The SAC (Smart Actuator Control) mode is applied to minimize the mechanical vibration. The SAC mode highly improves the actuator's settling time and tolerance coverage compared with conventional LSC (Linear Slope Control) mode. The DAC and eFlash are controlled via an I2C compatible serial interface.

The DW9763 incorporates with a POR (Power On Reset) circuit, power down mode. POR circuit gets to operate when VDD (supply power) turns on. The output current keeps 0mA until valid register value takes place. During the power down mode, it consumes current max.1uA.

The DW9763 is designed for auto focus and optical zoom for mobile camera, digital still camera, camcorders and other nano actuator applications.

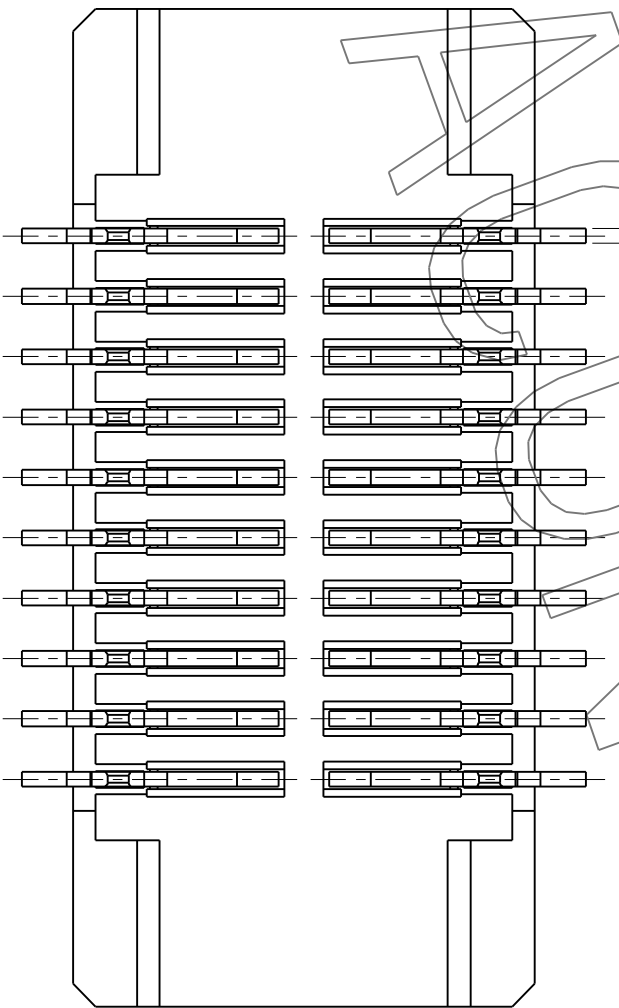
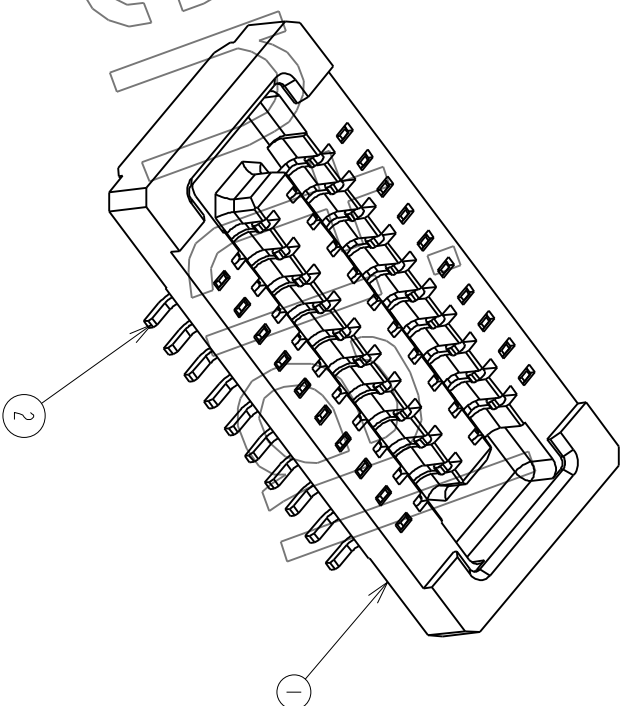
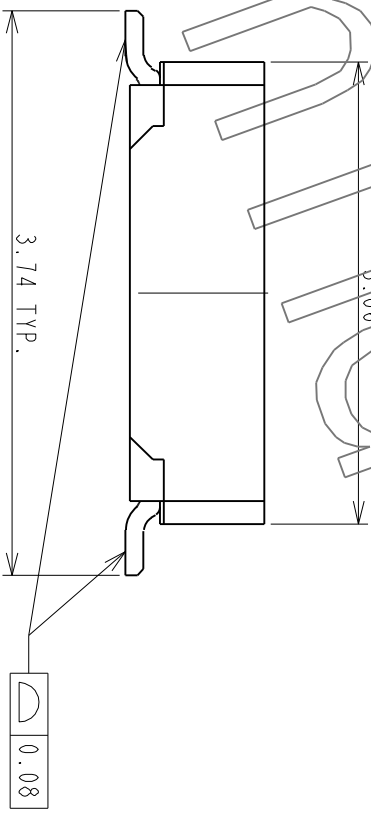
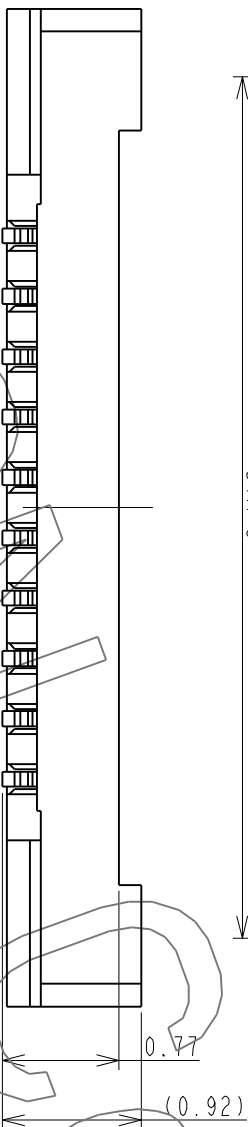
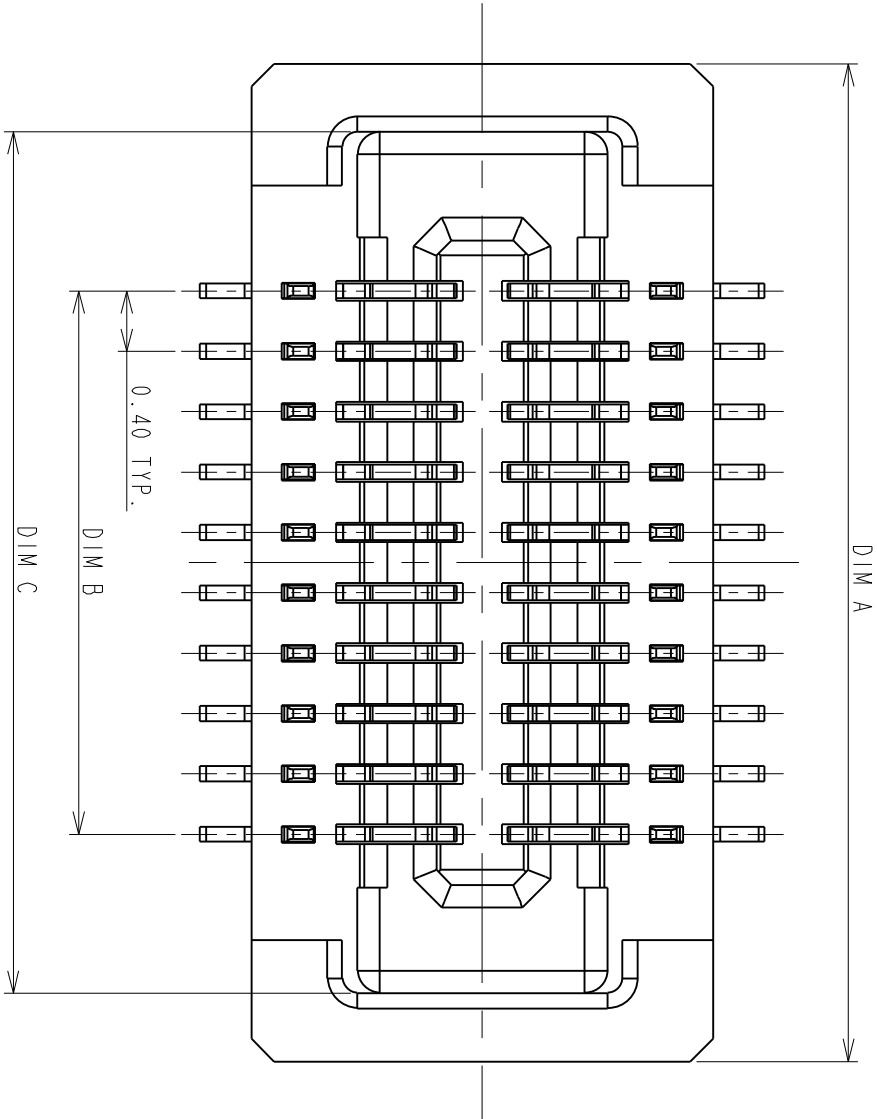
### ■ Features

- 10 bit resolution current sinking of 100mA for VCM
- SAC (Smart Actuator Control) mode
- Supply voltage range (VDD) : 2.3V to 3.3V
- Fast mode I2C interface compatible (1.8V interface available)
- Power down mode
- Power on reset (POR)
- Embedded 8KByte eFlash memory
- Package : 8 pin WLCSP
- Package Size : 0.77mm X 1.75mm X 0.3mm

### ■ Applications

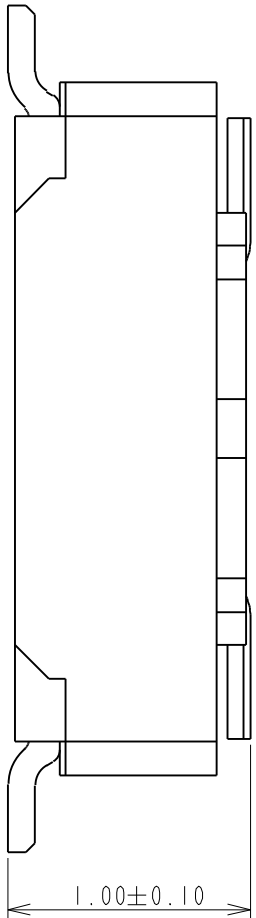
- Mobile camera
- Digital still camera
- Camcorder
- Web camera
- Nano actuator

REV.	EC#	DESCRIPTION	DATE	DRAWN	CHECKED	APPROVED
A	TJECR10018-02	NEW RELEASE PER NPI10009	11/05/10'	RAIN	DICK, SON	HARDWARE
B	TJECR13014	$\Delta$ X1, AX1	05/13/13'	RAIN	SteveM DESIGN	Jeff DESIGN



ITEM	NAME	Q'TY	PART #	MATERIAL / FINISH
2	CONTACT	XX	T-BBR43-100X30	COPPER ALLOY/PLATING GOLD
1	HOUSING	1	I-BBR43-1XXX33	HIGH TEMP RESIN/UL 94 V-0
TOLERANCES UNLESS OTHERWISE SPECIFIED				
GENERAL		XX	04/15/10'	RAIN
DESIGN		.XX	04/15/10'	RAIN
ANGLES		X° ±3.0°	04/15/10'	RAIN
SCALE		20:1	04/24/10'	RAIN
SHEET 1 OF 2		APPROVED	DATE	TITLE
UNIT		DICK, LEE	04/24/10'	P0.4*H1.0mm BOARD TO BOARD CONN. RECEPTACLE WITHOUT HOLD DOWN
CUSTOMER DRAWING		SERIES	BBR	SIZE A3
		DWG NO.	C-BBR43-04-01	REV. B





PRODUCT NUMBERING CODE:

BBR43	-	XX	K	X	5	X	X
1	2	3	4	5	6	7	

1. PRODUCTION CODE:

BBR43: BOARD TO BOARD 0.4 PITCH RECEPTACLE

2. POSITIONS:

XX: POSITIONS(SEE TABLE A

3. INSULATOR COLOR:

K: BLACK

4. CONTACT PLATING:

- 1: GOLD 1u" MIN
- 2: GOLD 5u" MIN
- 3: GOLD 10u" MIN
- B: GOLD 4u" MIN FOR SPOT PLATING
- ALL OVER: Ni 50~100u"

5. TYPE OF HEIGHT:

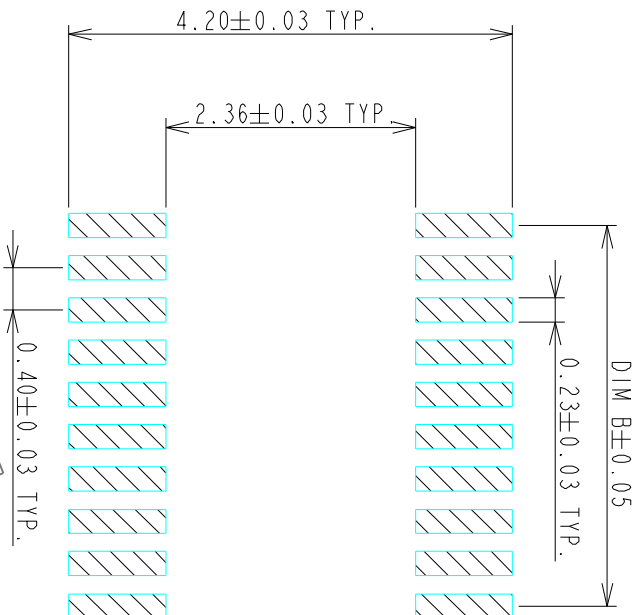
5: H=0.77mm

6. TYPE OF HOLD DOWN:

3: WITHOUT HOLD DOWN

7. OTHER

- 2: WITH POST, FINISHED PRODUCTS
- 3: WITHOUT POST, FINISHED PRODUCTS



RECOMMENDED P.C. BOARD PATTERN DIMENSION (WITHOUT HOLD DOWN)

NOTES:			
1.0: RATING:			
1.1: VOLTAGE: 60V AC/DC			
1.2: CURRENT: 0.5 AMPS			
1.3: OPERATION TEMPERATURE: -40°C TO +85°C			
2.0: ELECTRICAL CHARACTERISTIC:			
2.1: CONTACT RESISTANCE: 50 mΩ MAX INITIAL			
2.2: INSULATION RESISTANCE: 1000 MΩ MIN INITIAL			
2.3: DIELECTRIC WITHSTANDING VOLTAGE: 250V AC FOR ONE MINUTE			
3.0 TOLERANCES UNLESS OTHERWISE SPECIFIED			
GENERAL: DIMENSION >10.00	±0.13		
DIMENSION 5.00~10.00	±0.10		
DIMENSION <5.00	±0.05		

POSITIONS	DIM A	DIM B	DIM C
10	4.61	1.60	3.71
14	5.41	2.40	4.51
16	5.81	2.80	4.91
18	6.21	3.20	5.31
20	6.61	3.60	5.71
22	7.01	4.00	6.11
24	7.41	4.40	6.51
26	7.81	4.80	6.91
30	8.61	5.60	7.71
32	9.01	6.00	8.11
34	9.41	6.40	8.51
40	10.61	7.60	9.71
44	11.41	8.4	10.51
48	12.21	9.20	11.31
50	12.61	9.60	11.71
54	13.41	10.40	12.51
60	14.61	11.60	13.71
70	16.61	13.60	15.71
80	18.61	15.60	17.71

4.0 ALL COPLANARITY IS 0.08mm MAX. BEFORE REFLOW

ALL COPLANARITY IS 0.10mm MAX. AFTER REFLOW

TOLERANCES UNLESS OTHERWISE SPECIFIED		DRAWN		DATE	
GENERAL X <sub>1</sub>	±0.38	RAIN		04/15/10	
XX	±0.13	DESIGN		DATE	
XX	±0.05	RAIN		04/15/10	
ANGLES X <sub>1</sub>	±3.0°	CHECKED		DATE	
XX	±2.0°				
XX	±1.0°				
SCALE 20:1		HARDWARE	04/24/10		
SHEET 2 OF 2		APPROVED	DATE		
UNIT mm		DICK. LEE	04/24/10		
UNIT mm		CUSTOMER DRAWING			
TITLE		P0.4*11.0mm BOARD TO BOARD CONN. RECEPTACLE WITHOUT HOLD DOWN			
SERIES		BBR			
DWG NO.		C-BBR43-04-01			
REV.		B			





## Cameras Applications



Automotive Driver Pilot



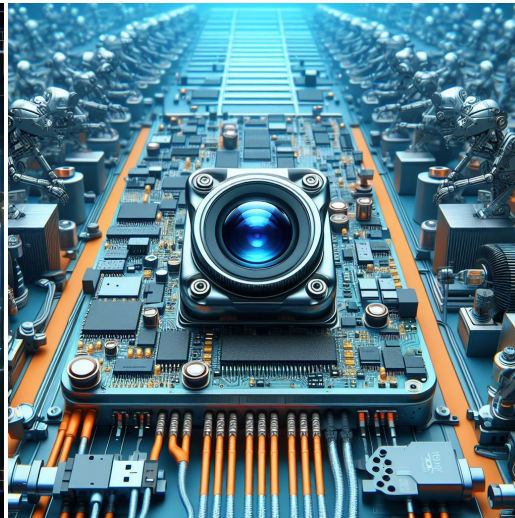
Live Streaming



Video Conference



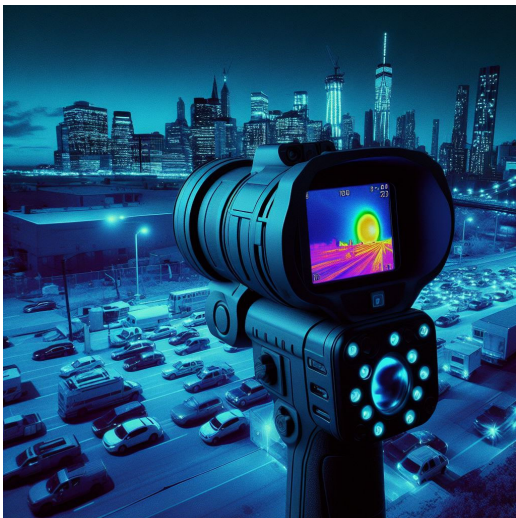
Eye Tracker Biometric Detection



Machine Vision



Agricultural Monitor



Night Vision Security

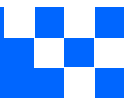


Drone and Sports Eagle Eyes



Interactive Pet Camera





## Cameras Applications

*your BEST camera module partner*



## IMAGING DEVICES



## Camera Module Pinout Definition Reference Chart

OmniVision Sony Samsung On-Semi Aptina Himax GalaxyCore PixArt SmartSens Sensors	
Pin Signal	Description
DGND GND	ground for digital circuit
AGND	ground for analog circuit
PCLK DCK	DVP PCLK output
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor
MCLK XVCLK XCLK INCK	system input clock
RESET RST	reset active low with internal pull-up resistor
NC NULL	no connect
SDA SIO_D SIOD	SCCB data
SCL SIO_C SIOC	SCCB input clock
VSYNC XVS FSYNC	DVP VSYNC output
HREF XHS	DVP HREF output
DOVDD	power for I/O circuit
AFVDD	power for VCM circuit
AVDD	power for analog circuit
DVDD	power for digital circuit
STROBE FSTROBE	strobe output
FSIN	synchronize the VSYNC signal from the other sensor
SID	SCCB last bit ID input
ILPWM	mechanical shutter output indicator
FREX	frame exposure / mechanical shutter
GPIO	general purpose inputs
SLASEL	I2C slave address select
AFEN	CEN chip enable active high on VCM driver IC
<b>MIPI Interface</b>	
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st data lane negative output
MDP0 DP0 MD0P DATA_P DMO1P	MIPI 1st data lane positive output
MDN1 DN1 MD1N DATA2_N DMO2N	MIPI 2nd data lane negative output
MDP1 DP1 MD1P DATA2_P DMO2P	MIPI 2nd data lane positive output
MDN2 DN2 MD2N DATA3_N DMO3N	MIPI 3rd data lane negative output
MDP2 DP2 MD2P DATA3_P DMO3P	MIPI 3rd data lane positive output
MDN3 DN3 MD3N DATA4_N DMO4N	MIPI 4th data lane negative output
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output
MCN CLKN CLK_N DCKN	MIPI clock negative output
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output
<b>DVP Parallel Interface</b>	
D0 DO0 Y0	DVP data output port 0
D1 DO1 Y1	DVP data output port 1
D2 DO2 Y2	DVP data output port 2
D3 DO3 Y3	DVP data output port 3
D4 DO4 Y4	DVP data output port 4
D5 DO5 Y5	DVP data output port 5
D6 DO6 Y6	DVP data output port 6
D7 DO7 Y7	DVP data output port 7
D8 DO8 Y8	DVP data output port 8
D9 DO9 Y9	DVP data output port 9
D10 DO10 Y10	DVP data output port 10
D11 DO11 Y11	DVP data output port 11

## Camera Reliability Test

Reliability Inspection Item			Testing Method	Acceptance Criteria
Category		Item		
Environmental	Storage Temperature	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation
	Operation Temperature	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation
	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation
	Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation
Physical	Drop Test (Free Falling)	Without Package 60cm	10 Times on Wood Floor	Electrically Functional
		With Package 60cm	10 Times on Wood Floor	Electrically Functional
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional
	Cable Tensile Strength Test	Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional
Electrical	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional
		Air Discharge 4 KV	ESD Testing Machine	Electrically Functional
	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional



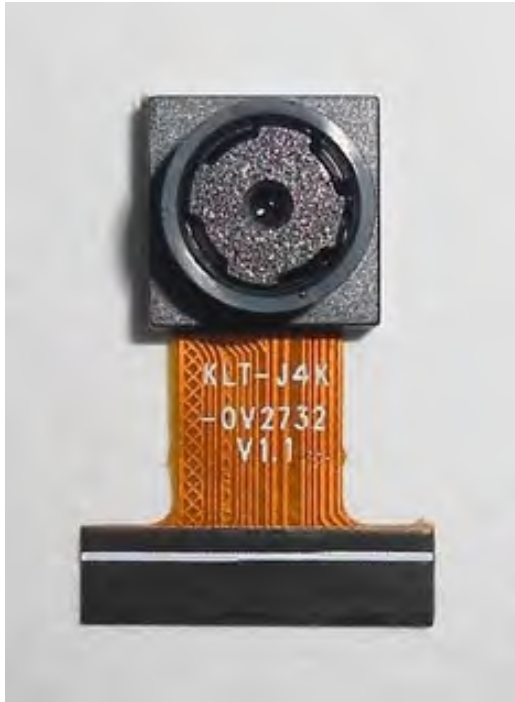


Inspection Item			Inspection Method	Standard of Inspection	
Category		Item			
Appearance	FPC/ PCB	Color	The Naked Eye	Major Difference is Not Allowed.	
		Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.	
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)	
	Holder	Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed	
		Gap	The Naked Eye	Meet the Height Standard	
		Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)	
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed	
	Lens	Scratch	The Naked Eye	No Effect On Resolution Standard	
		Contamination	The Naked Eye	No Effect On Resolution Standard	
		Oil Film	The Naked Eye	No Effect On Resolution Standard	
		Cover Tape	The Naked Eye	No Issue On Appearance.	
	Function	Image	No Communication	Test Board	Not Allowed
			Bright Pixel	Black Board	Not Allowed In the Image Center
Dark Pixel			White board	Not Allowed In the Image Center	
Blurry			The Naked Eye	Not Allowed	
No Image			The Naked Eye	Not Allowed	
Vertical Line			The Naked Eye	Not Allowed	
Horizontal Line			The Naked Eye	Not Allowed	
Light Leakage			The Naked Eye	Not Allowed	
Blinking Image			The Naked Eye	Not Allowed	
Bruise			Inspection Jig	Not Allowed	
Resolution			Chart	Follows Outgoing Inspection Chart Standard	
Color			The Naked Eye	No Issue	
Noise			The Naked Eye	Not Allowed	
Corner Dark			The Naked Eye	Less Than 100px By 100px	
Color Resolution			The Naked Eye	No Issue	
Dimension			Height	The Naked Eye	Follows Approval Data Sheet
		Width	The Naked Eye	Follows Approval Data Sheet	
		Length	The Naked Eye	Follows Approval Data Sheet	
		Overall	The Naked Eye	Follows Approval Data Sheet	



## KLT Package Solutions

KLT Camera Module



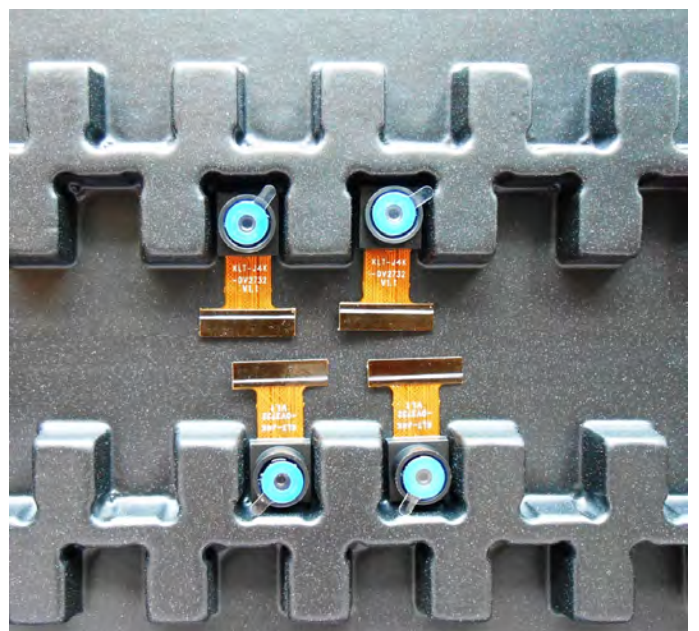
Complete with Lens Protection Film



Tray with Grid and Space

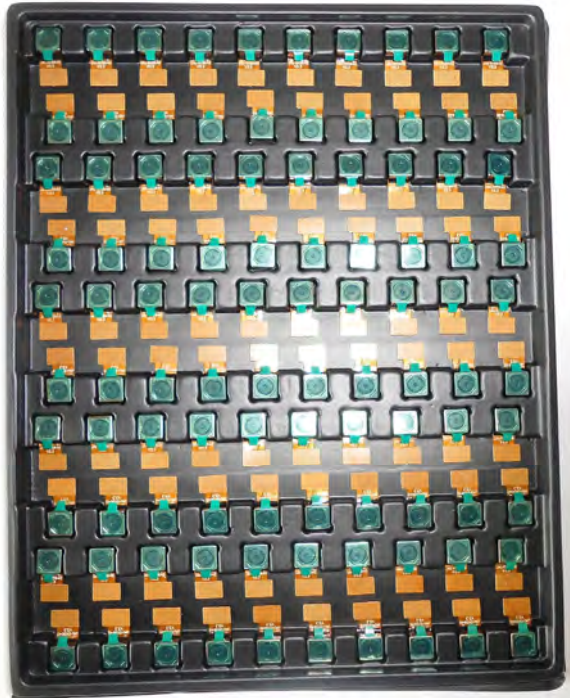


Place Cameras on the Tray



## Camera Modules Package Solution

Full Tray of Cameras



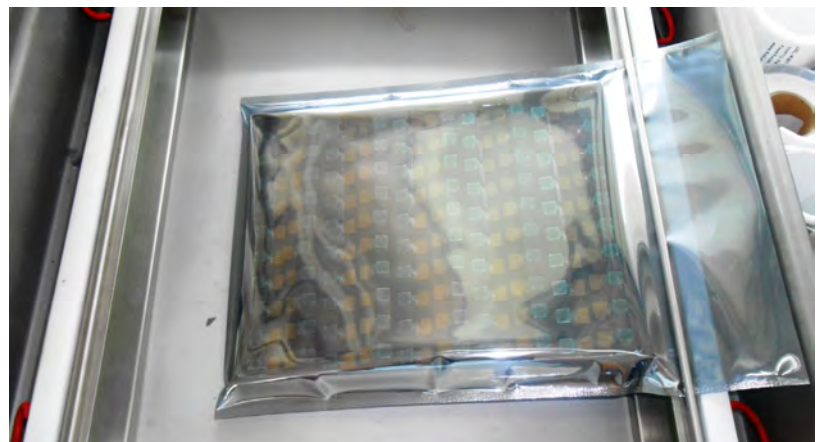
Cover Tray with Lid



Put Tray into Anti-Static Bag



Vacuum the Anti-Static Bag





## Camera Modules Package Solution

**Sealed Vacuum Bag with Labels**

**1. Model and Description 2. Quantity 3. Shipping Date 4. Caution**



## Large Order Package Solution

Place Foam Sheets Between Trays



Foam Sheets are Slightly Larger than Trays



Place Foam Sheets and Trays into Box



Foam Sheets are Tightly Fitting Box





## Small Order Package Solution

Place Foam Sheets and Trays into Small Box



Foam Sheets are Nicely Fitting the Small Box



Package in Small Box for Shipment



Place Small Boxes into Larger Box



## Carbon Box Package Solution

Seal the Carbon Box

Final Package Labelled Box



### Carbon Box Ready for Shipment

1. Delivery Address and Phone No. 2. Box No. and Ship Date 3. Fragile Caution





## Sample Order Package Solution

Place Sample into Small Anti-Static Bag



Place Connectors into Small Ant-Static Bag



### Sample Labels on the Small Bag

1. Camera Module or Connector Model 2. Shipping Date and Quantity 3. Caution



## Connectors Large Order Package Solution

Connectors in a Wheel



Label Connectors in the Wheel



The Wheel is Perfectly Fitting the Box



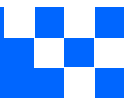
Connectors Box Ready for Shipment







# CMOS CAMERA MODULES



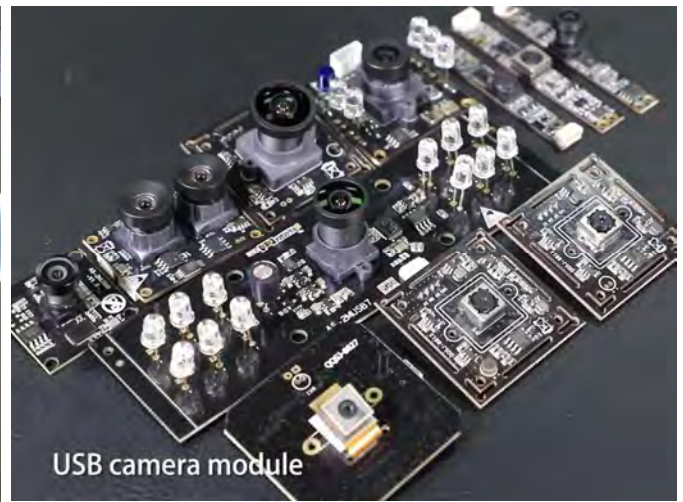
*your BEST camera module partner*

## Company Kai Lap Technologies (KLT)

Kai Lap Technologies Group Limited. (KLT) was established in 2009, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. KLT is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

KLT provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. KLT specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.



## Limited Warranty

KLT provides the following limited warranty if you purchased the Product(s) directly from KLT company or from KLT's website, [www.KaiLapTech.com](http://www.KaiLapTech.com). Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. KLT guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, KLT will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of KLT is solely limited to repair and/or replacement on the terms set forth above. KLT is not reliable or responsible for any subsequent events.



[www.KaiLapTech.com](http://www.KaiLapTech.com) [sales@KaiLapTech.com](mailto:sales@KaiLapTech.com) Tel: (852) 6908 1256 Fax: (852) 3017 6778



# CMOS CAMERA MODULES



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## KLT Strength

### Powerful Factory



### Professional Service



### Promised Delivery



[www.KaiLapTech.com](http://www.KaiLapTech.com) [sales@KaiLapTech.com](mailto:sales@KaiLapTech.com) Tel: (852) 6908 1256 Fax: (852) 3017 6778

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